Form PTO-1449 Attorney Docket No. Serial No. 10/734,075 62004-1851 To be assigned 10/135,314 Parent) INFORMATION DISCLOSURE CITATION Applicant Mule, et al. (Use several sheets if necessary) Filing Date: 12/11/03 Group (4/29/02 Parent) TBA (2874 Parent) U.S. PATENT DOCUMENTS Examiner Item Document Date Name Class Subclass Initials Filing Date Number If Appropriate Α 4,732,446 3/22/88 Gipson, et al. 350 96.15 10/2/85 В 4,943,136 7/24/90 Alexander A. Popoff 350 96.16 12/9/88 C 5,037,173 8/6/91 Sampsell, et al. 385 17 11/22/89 D 5,039,189 8/13/91 Lytel, et al. 385 2 4/6/90 E 5,073,000 12/17/91 Dennis Derfiny 385 14 5/21/90 F 5,101,460 3/31/92 Fred V. Richard 385 37 9/4/90 G 5,159,770 10/27/92 Reid, deceased et al. 385 14 3/13/91 Н 5,224,184 6/29/93 Boudreau 385 35 5/21/91 I 5,245,680 9/14/93 Gerald F. Sauter 385 24 2/5/93-J 5,296,950 3/22/94 Lin et al. 359 9. 1/31/92 K 5,263,111 11/16/93 Nurse et al. 385 130 2/26/92 FOREIGN PATENT DOCUMENTS Document Date Country Class Subclass Translation Number Yes No. OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.) Chen, et al.; Fully Embedded Board-Level Guided-Wave Optoelectronic Interconnects; June, 2000; Proceedings of the IEEE, Vol. 88, No. 6; pp 780-793 Wiesmann, et al.; Singlemode Polymer Waveguides For Optical Backplanes, December 5, 1996; Electronics Letters, Vol. 32, No. 25; pp 2329-2330 Barry, et al.; Highly Efficient Coupling Between Single-Mode Fiber and Polymer Optical Waveguides; August, 1997; IEEE Transactions on Components, Packaging, and Manufacturing Technology - Part B, Vol. 20, No. 3; pp 225-228 Lee, et al.; Fabrication of Polymeric Large-Core Waveguides for Optical Interconnects Using a Rubber Molding Process, January, 2000, IEEE Photonics Technology Letters, Vol. 12, No. 1, pp 62-64 Schmeider, et al.; Electro-Optical Printed Circuit Board (EOPCB); 2000 Electronic Components and Technology Conference; pp 749-753 Mederer, et al., 3Gb/s Data Transmission With GaAs VCSELs Over PCB Integrated Polymer Waveguides; September, 20001; ATHP IEEE Photonics Technology Letters, Vol. 13, No. 9; pp 1032-1034 • EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP § 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant. EXAMINER'S SIGNATURE Plant. H. Palma DATE CONSIDERED: Patent and Trademark Office; U. S. DEPARTMENT OF COMMERCE

Form PTO-1449 Attorney Docket No. Serial No. TBA 62004-1851 (10/135,314 Parent) INFORMATION DISCLOSURE CITATION Applicant -Mule, et al. (Use several sheets if necessary) Filing Date 12/11/03 Group TBA (4/29/02 Parent) (2874 Parent) **U.S. PATENT DOCUMENTS** Examiner Item Document Date Name Class Subclass Initials Filing Date Number If Appropriate R 5,276,762 1/4/94 Hartman, et al. 385 137 3/2/92 S 5,296,950 3/22/94 Lin, et al. 359 9 1/31/92 Т 5,313,536 5/17/94 Rossi, et al. 385 14 12/15/92 U 5,337,388 8/9/94 Jacobowitz, et al. 385 76 8/3/93 ٧ 5,371,820 12/6/94 Welbourn, et al. 385 76 1/9/92 W 5,396,573 3/7/95 Ecker, et al. 385 88 8/3/93 X 5,408,567 4/18/95 Hamilton 385 132 12/1/93 Y 5,416,861 5/16/95 Koh, et al. 385 14 4/29/94 Z 5,418,360 5/23/95 Sokolowska, et al. 250 227.12 1/21/94 AΑ 5,432,630 7/11/95 Lebby, et al. 359 152 9/11/92 5,442,475 8/15/95 Bausman, et al. 359 140 4/21/94 FOREIGN PATENT DOCUMENTS Document Date Country Class Subclass Number Translation Yes No OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.) CC Schröder, et al.; Polymer Optical Interconnects for PCB; 2001; Session 13: Photonic Polymers II; pp 337-343 Glukh, et al.; High-performance Polymeric Materials for Waveguide Applications, August, 2000, SPIE - The International Society DD for Optical Engineering, Linear, Nonlinear and Power Limiting Organics, San Diego, Volume 4106, pp 1-11 Liu, et al., Plastic VCSEL Array Packaging and High Density Polymer Waveguides for Board and Backplane Optical Interconnect; EE 1998; Electronic Components and Technology Conference, pp 999-1005 • EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP § 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant. EXAMINER'S SIGNATURE: DATE CONSIDERED: Patent and Trademark Office; U. S. DEPARTMENT OF COMMERCE

ir.

Form PTO-1449 Attorney Docket No. Serial No. TBA 62004-1851 (10/135,314 Parent) INFORMATION DISCLOSURE CITATION **Applicant** 10/234,075 Mule, et al. (Use several sheets if necessary) Filing Date 12/11/03 Group (4/29/02 Parent) TBA (2874 Parent) U.S. PATENT DOCUMENTS Examiner Item Document Date Name Class Initials Subclass Filing Date Number If Appropriate FF 5,450,508 9/12/95 Decusatis, et al. 385 25 12/8/94 GG 5,469,518 11/21/95 Song, et al. 385 89 12/15/94 НН 5,499,311 3/12/96 Casimer M. DeCusatis 385 89 12/16/94 II 5,521,992 5/28/96 Chun, et al. 385 14 8/1/94 IJ 5,548,771 8/20/96 Lin, et al. 395 800 10/14/94 KK 5,568,574 10/22/96 Tanguay, Jr., et al. 385 14 6/12/95 LL 5,611,014 3/11/97 Nagesh R. Basavanhally 385 90 12/7/94 MM 5,649,045 7/15/97 Fjare, et al. 385 145 12/13/95 NN 5,652,811 7/29/97 Cook, et al. 385 14 3/6/96 00 5,659,641 DeMeritt, et al. 8/19/97 385 14 12/22/95 PP 5,757,989 5/26/98 Yoshimura, et al. 385 14 9/10/93 QQ 5,761,350 6/2/98 Seungug Koh 385 14 1/22/97 RR5,774,614 6/30/98 Gilliland, et al. 385 88 7/16/96 SS 5,835,646 11/10/98 Yoshimura, et al. 385 14 8/9/96 TT 5,841,927 11/24/98 Watanabe, et al. 385 129 9/16/94 ŬŪ 5,842,881 12/1/98 Ecker, et al. 439 329 8/3/93 ٧V 5,854,868 12/29/98 Yoshimura, et al. 385 50 8/9/96 · ww 5,864,642 1/26/99 Chun, et al. 385 14 2/10/97 XX 5,902,715 5/11/99 Tsukamoto, et al. 430 290 4/2/97 YY 5,923,451 7/13/99 Karstensen, et al. 359 163 9/26/95 ZZ 5,929,518 7/27/99 Andrew J. Schlaiss 257 712 7/20/97 FOREIGN PATENT DOCUMENTS Document Date Country Class Subclass Translation Number Yes No OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.) \* EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP § 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant. EXAMINER'S SIGNATURE: DATE CONSIDERED: Patent and Trademark Office, U. S. DEPARTMENT OF COMMERCE

INFORMATION DISCLOSURE CITATION  Applie Mule,					Attorney Do 62004-1851	1851 (1		Serial No. TBA (10/135,314 Parent)	
					Applicant Mule, et al.				
(Use several sheets					(4/29/02 Parent)			Group TBA (2874 Parent)	
F	<del>1. i</del>		U.S. PA	ATENT DOCUMEN	TS			- un cirt)	
Examiner Initials	Item	Document Number	Date	Nam	ıe	Class	Subclass	Filing Date	
TINT -	aa	6,049,639	4/11/00	Paniccia, et al.		385	14	<del> </del>	
PVN Y	bb	6,052,498	4/18/00	Mario J. Paniccia		385	14	12/19/97	
N/A	СС	6,065,881	5/23/00	Okada, et al.	<del></del>	385	88	12/19/97	
WHY	dd	6,071,017	6/6/00	Gilliland, et al.		385	93	10/2/98	
PTHY	ee	6,081,632	6/27/00	Yoshimura, et al.		385	5	6/10/98	
NTHY	ff	6,141,072	10/31/00	Drabik, et al.	<del></del>	349	122	10/16/97	
Val.	gg	6,162,838	12/19/00	Paul A. Kohl		521	<del></del>	4/2/98	
onp	hh	6,165,890	12/26/00	Kohl, et al.	<u> </u>	438	77	6/4/99	
THE	ii	6,179,627	1/30/01	Daly, et al.		438	619	1/21/98	
viy	_ii	6,185,648	2/6/01	Munoz-Bustamante,	et al	<del> </del>	76.1	9/25/98	
VILP	kk	6,215,585	4/10/01	Yoshimura, et al.		710	126	3/31/99	
VOIP	11	6,226,429	5/1/01	Hikita, et al.		359	344	2/6/98	
W	mm	6,285,813	9/4/01	Schultz, et al.	<del></del>	385	50	9/15/00	
PTUP	nn	6,332,050	12/18/01	Feldman, et al.	1, 11	385	37	10/2/98	
Mr.	.00	6,343,171	1/29/02	Yoshimura, et al.	<u> </u>	385	24	4/5/00	
TOT ]	pp	Re. 36, 820	8/15/00	McGinley		385	50	4/20/99	
· · · · · · · · · · · · · · · · · · ·			FOREIGN F	PATENT DOCUMEN	VTC	361	752	6/3/98	
	Document Number		Date			Class	Subclass	Translation	
								Yes No	
	<del>!</del>	OTHER DOCUM	ENTS (Includi	ng Author, Title, Dat					
			- Includi	ng Aumor, Title, Dat	e. Pertinent Pa	iges, etc.)			
EXAMINEI Ormance an	R: Initial i	f citation considered, when	her or not citation	is in conformance with M	MPEP § 609. Dra	w line thro	ugh citation i		
AMINER'	S SIGNA	idered. Include copy of the TURE: Plan	T. H. P.	DATE CO	olicant.  ONSIDERED:	Inc 1110	agn citation if	not in	
			, , (, ) (	Patent and Tradema	-1 om -	05/10	404		